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MOSFET - Power, Single N-Channel, DFN5/DFNW5 60 V, 6.1 mΩ, 71 A

NVMFS5C670NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C670NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted) Parameter Symbol Value Unit V Drain-to-Source Voltage VDSS 60 Gate-to-Source Voltage V_{GS} v ±20 Continuous Drain $T_{\rm C} = 25^{\circ}{\rm C}$ 71 A I_D Current R_{0JC} $T_{\rm C} = 100^{\circ}{\rm C}$ 50 (Notes 1, 3) Steady State PD Power Dissipation $T_{C} = 25^{\circ}C$ 61 W $R_{\theta,IC}$ (Note 1) $T_{\rm C} = 100^{\circ}{\rm C}$ 31 $T_A = 25^{\circ}C$ Continuous Drain 17 А I_D Current R_{0JA} $T_A = 100^{\circ}C$ 12 (Notes 1, 2, 3) Steady State Power Dissipation w $T_A = 25^{\circ}C$ P_D 3.6 R_{0JA} (Notes 1 & 2) $T_A = 100^{\circ}C$ 1.8 Pulsed Drain Current $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ 440 A IDM °C Operating Junction and Storage Temperature T_J, T_{stg} -55 to + 175Source Current (Body Diode) 68 А I_S Single Pulse Drain-to-Source Avalanche E_{AS} mJ 166 Energy $(I_{L(pk)} = 3.6 \text{ A})$ Lead Temperature for Soldering Purposes T_{L} 260 °C (1/8" from case for 10 s)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

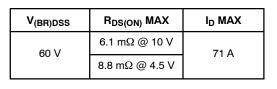
THERMAL RESISTANCE MAXIMUM RATINGS

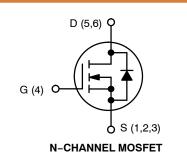
Parameter	Symbol	Value	Unit	
Junction-to-Case - Steady State	$R_{\theta JC}$	2.4	°C/W	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	41		

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



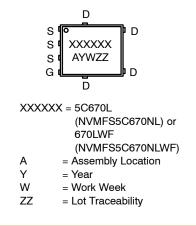




DFN5 (SO-8FL) CASE 488AA

DFNW5 (FULL-CUT SO8FL WF) CASE 507BA

MARKING DIAGRAM



ORDERING INFORMATION

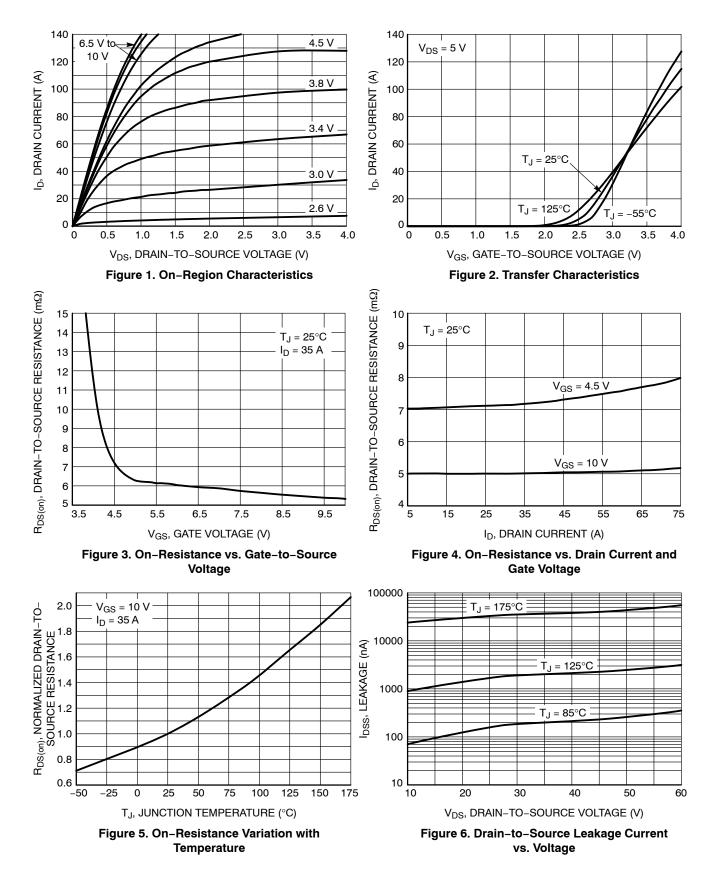
See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

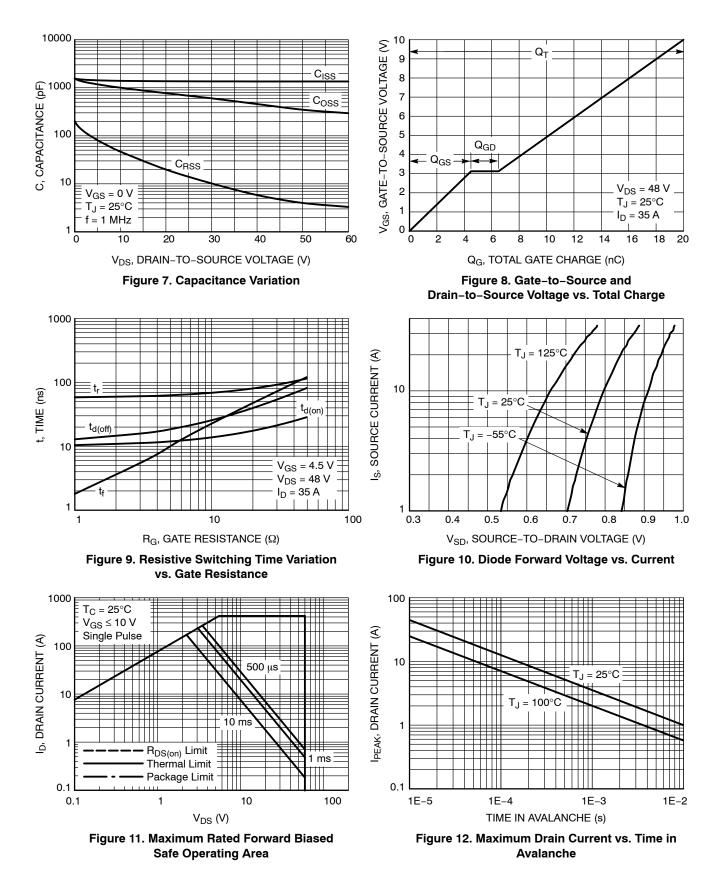
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	<u>.</u>	-					
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D =	= 250 μA	60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				27		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	T _J = 25 °C			10	
		V _{DS} = 60 V	T _J = 125°C			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	₆ = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 53 \ \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-4.7		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 35 A		5.1	6.1	0
		V _{GS} = 4.5 V	I _D = 35 A		7.0	8.8	mΩ
Forward Transconductance	9FS	V _{DS} = 15 V, I _E	₀ = 35 A		82		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			1400		pF
Output Capacitance	C _{OSS}				690		
Reverse Transfer Capacitance	C _{RSS}			15			
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 48 V; I_{D} = 35 A			9.0		nC
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 48 V; I_{D} = 35 A			20		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 35 A			2.5		
Gate-to-Source Charge	Q _{GS}				4.5		nC
Gate-to-Drain Charge	Q _{GD}				2.0		
Plateau Voltage	V _{GP}				3.1		V
SWITCHING CHARACTERISTICS (Note 5)						
Turn-On Delay Time	t _{d(ON)}	V _{GS} = 4.5 V, V _{DS} = 48 V, I _D = 35 A, R _G = 2.5 Ω			11		
Rise Time	tr				60		ns
Turn-Off Delay Time	t _{d(OFF)}				15		
Fall Time	t _f				4		
DRAIN-SOURCE DIODE CHARACTERIS	TICS				•		
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 35 A	$T_J = 25^{\circ}C$		0.9	1.2	
			T _J = 125°C		0.8		V
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dI _S /d _t = 100 A/µs, I _S = 35 A			34		ns
Charge Time	ta				17		
Discharge Time	t _b				17		
Reverse Recovery Charge	Q _{RR}				19		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \,\mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

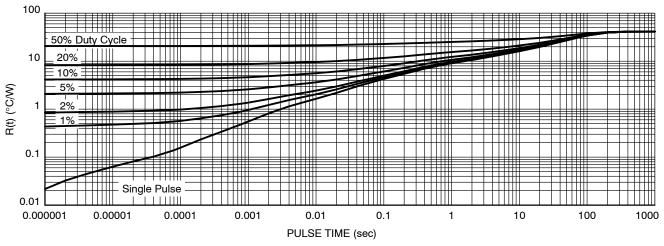


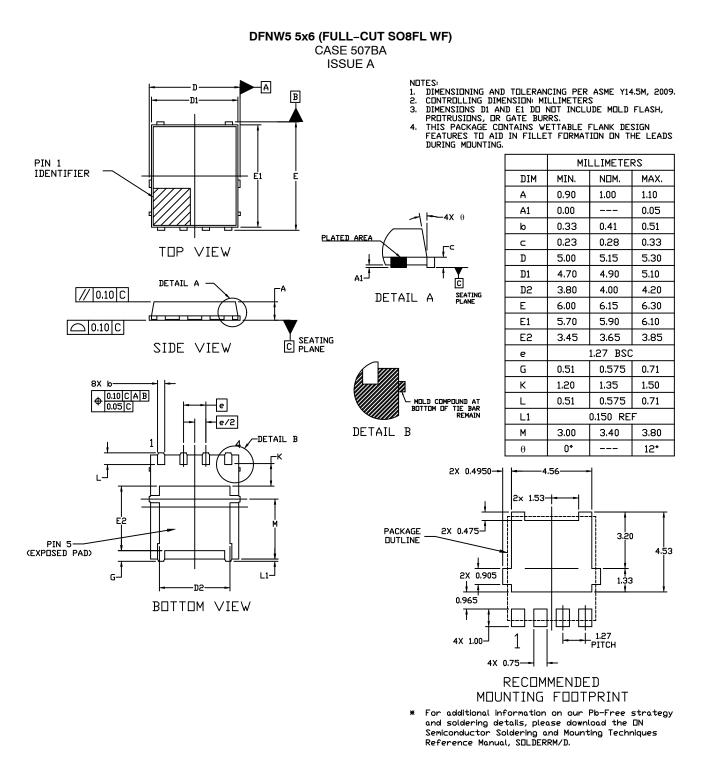
Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†]	
NVMFS5C670NLT1G	5C670L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C670NLWFT1G	670LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C670NLT3G	5C670L	DFN5 (Pb-Free)	5000 / Tape & Reel	
NVMFS5C670NLWFT3G	670LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel	
NVMFS5C670NLAFT1G	5C670L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C670NLAFT1G-YE	5C670L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C670NLWFAFT1G	670LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C670NLWFAFT3G	670LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel	

DEVICE ORDERING INFORMATION

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



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